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User Guide for
FEBFOD8012_RS485
Evaluation Board

Bi-Directional Logic Gate Optocoupler
Provides Proven and Reliable Isolation to
the RS485 Interface

Featured Fairchild Product:
FOD8012

***Direct questions or comments
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Fairchild Semiconductor.com

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This user guide supports the evaluation kit for the FOD8012. It should be used in conjunction with the FOD8012 datasheet as well as Fairchild's application notes and technical support team. Please visit Fairchild's website at www.fairchildsemi.com.

1. Introduction

The FOD8012 is an industry-first, full-duplex, bi-directional, logic-gate optocoupler with high noise immunity as well as proven and reliable optical isolation. It is highly integrated with two optically coupled channels arranged in a bi-directional configuration illustrated in Figure 1. The FOD8012 is housed in a compact 8-pin small outline package. Each optocoupler channel consists of a high-speed AlGaAs LED driven by a CMOS buffer IC coupled to a CMOS detector IC.

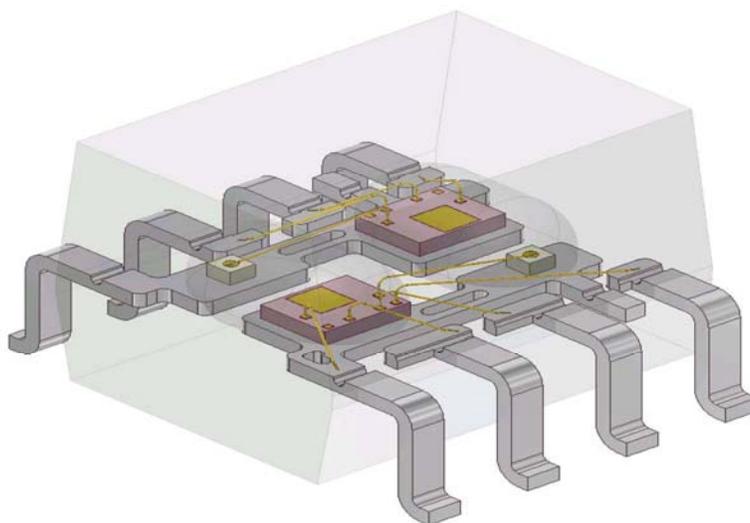


Figure 1. 3-Dimensional Illustration of the Internal Die Set of Fairchild's Optoplanar® Package Construction

1.1. Description

The FOD8012 supports isolated communication between systems of digital signals without conducting ground loops or hazardous voltages. Unlike competitive devices, which provide less than 0.1 mm optical isolation gap, the FOD8012 features a 0.4 mm (minimum) optical isolation gap for proven, reliable isolation. The device also features a fast switching speed, up to 15Mbit/sec, and uses Fairchild's Optoplanar® packaging technology and optimized IC design to achieve high Common Mode Rejection (CMR) of 20 kV/ μ s minimum, allowing the device to operate in noisy industrial environments.

Additionally, the FOD8012 offers an extended industrial temperature range of -40°C to +110°C and a 3.3 V or 5.0 V supply voltage to facilitate logic level translation. The device's high isolation voltage is certified by UL1577 and DIN_EN/IEC60747-5-2 for increased reliability.

2. Photographs

The evaluation board kit includes the FOD8012, a bi-directional logic-gate optocoupler that isolates the driver input and receiver output of a half-duplex 3.3V RS485 transceiver. In addition, a single-channel logic-gate optocoupler with open collector output, FODM8061, isolates the driver-enable pin of the transceiver.

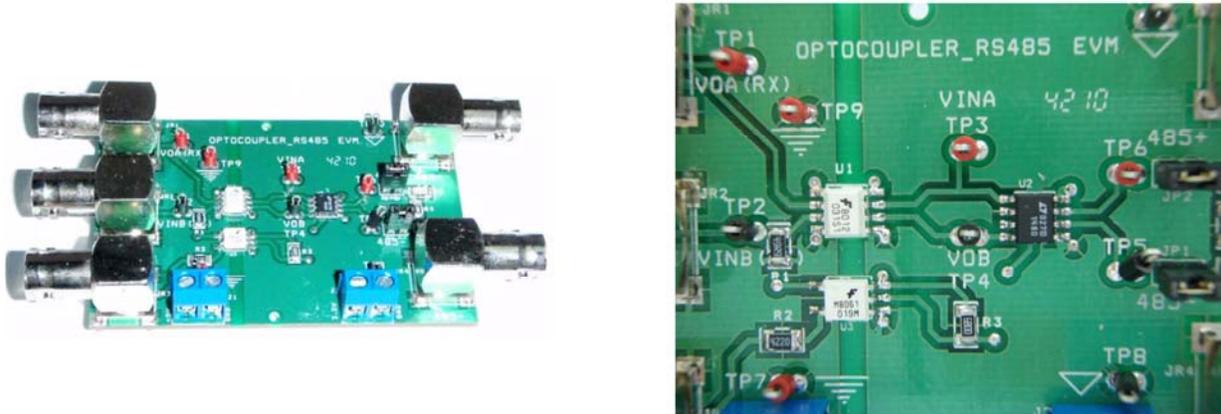


Figure 2. Photographs of the FEBFOD8012_RS485 Board

3. Printed Circuit Board

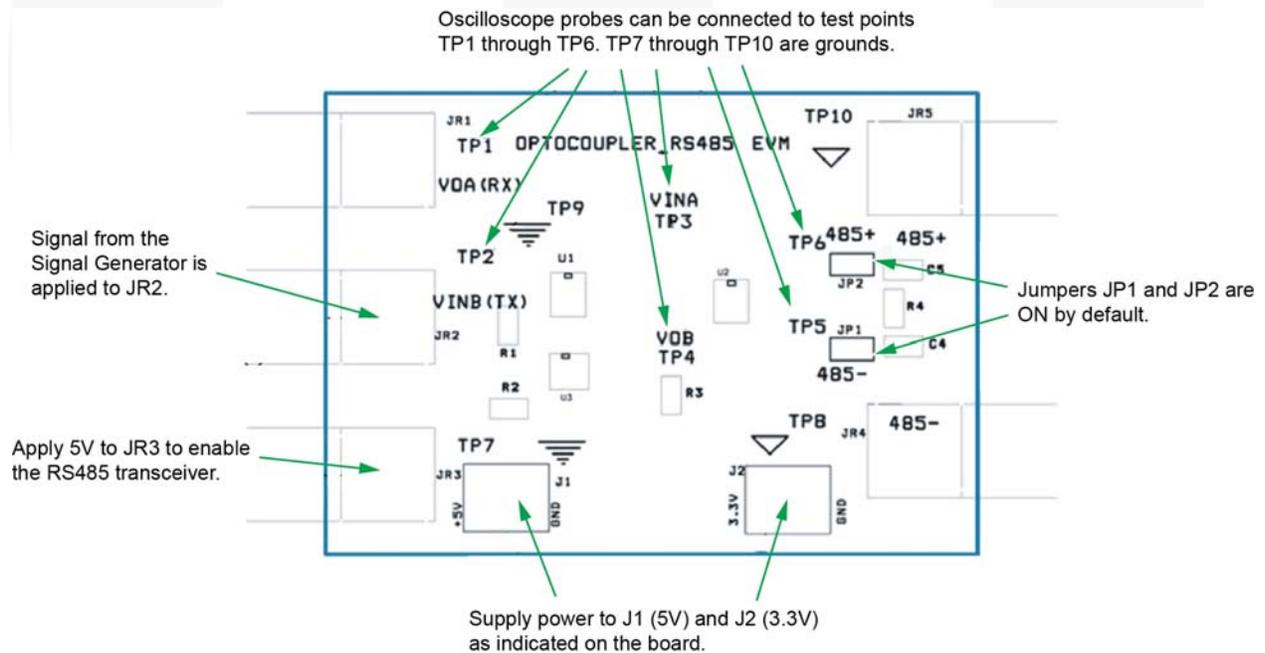


Figure 3. FEBFOD8012_RS485 Board Setup

3.1. Board Setup and Operation

The FEBFOD8012_RS485 evaluation board enables users to make a quick and accurate assessment of Fairchild's FOD8012 in a bi-directional data transmission application. The setup requires two power supply sources. V_{DD1} (J1) is on one side of the isolation barrier with V_{DD2} and VCC (J2) is on the other side of the isolation barrier, sharing the same power supply source. A square wave is applied to one of the FOD8012 channels (VINB / VOB), which in turn drives the RS485 transceiver. The resulting RS485 output is fed back to the input of the other FOD8012 channel (VINA / VOA). This completes the bi-directional data transmission loop. Test points located at selected positions (as indicated in Figure 3 and Figure 4) allow the user to probe the signals and measure the switching characteristics of the device.

3.2. Test Procedures and Conditions

The steps below and Figure 3 describe the default setup of the FEBFOD8012_RS485 evaluation board.

1. Jumpers JP1 and JP2 are connected on the board by default. They connect the RS485 transceiver output to the resistive and capacitive loads: R4 (54 Ω), and C4 and C5 (each 100 pF), respectively. The user has the flexibility of connecting the RS485 driver output/receiver inputs to another load / signal source using the BNC (485+ and 485-) connectors and removing the jumpers (not covered in this document).
2. With the power off, connect the power supplies to the board. They are set to 5.0 V (J1) or 3.3 V (J2), as specified on the board. Make sure that the supply voltages do not exceed the absolute maximum rating of the devices, as this may damage the devices.
3. Turn on the power supplies.
4. Apply a "HIGH" (5.0 V) to the BNC connector JR3 to enable the RS485 transceiver. The user can synchronize the signal at JR3 with that at JR2 using another signal source (e.g., using a dual-output signal generator). Application of a constant 5.0 V to JR3 using a power supply is also sufficient.
5. Connect the output of the signal generator to the BNC connector (JR2). The signal generator settings are: square wave = 1.25 MHz, duty cycle = 50%, amplitude = 5.0 V, output impedance = 50 Ω .
6. Enable the signal generator. The signal waveforms can be probed at various test points, as shown in Figure 3:
 - TP1: VOA (RX) is the output voltage from channel-A of the FOD8012.
 - TP2: VINB (TX) is the input voltage to channel-B of the FOD8012. Signal from the signal generator is applied here.
 - TP3: VINA is the input voltage to channel-A of the FOD8012. This signal is supplied by the RS485 transceiver.
 - TP4: VOB is the output voltage from channel-B of the FOD8012, which in turn drives the input of the RS485 transceiver.
 - TP5 & TP6: 485+ and 485- are the RS485 transceivers outputs.
 - TP7 to TP10: grounds.

4. Schematic

The FEBFOD8012_RS485 board is designed for evaluation of the FOD8012 timing sequence and AC test performance with an RS485 transceiver. It should be used in conjunction with the product datasheet.

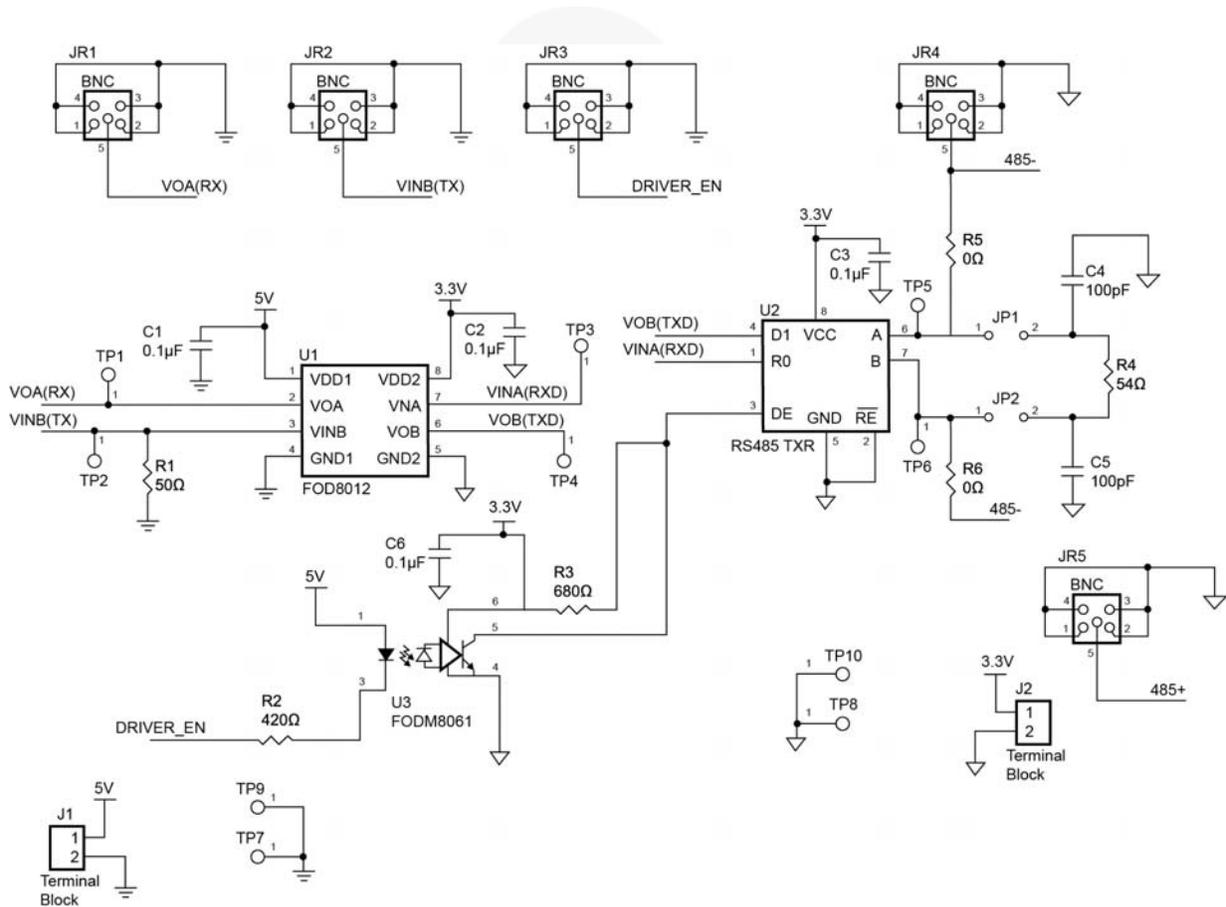


Figure 4. Evaluation Board Schematic

5. Scope Shots

The scope shots in Figure 5 through Figure 7 illustrate normal operation of the RS485 data transfer via the isolated channels of the FOD8012. Refer to Figure 4 for the circuit schematic.

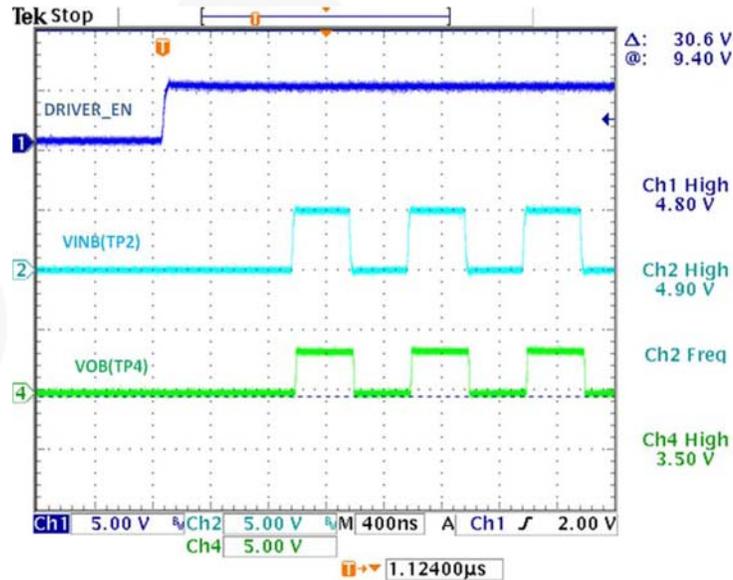


Figure 5. DRIVER_EN and VINB are Input Signals; FOD8012 Output Signal, VOB, Drives RS485 Transceiver

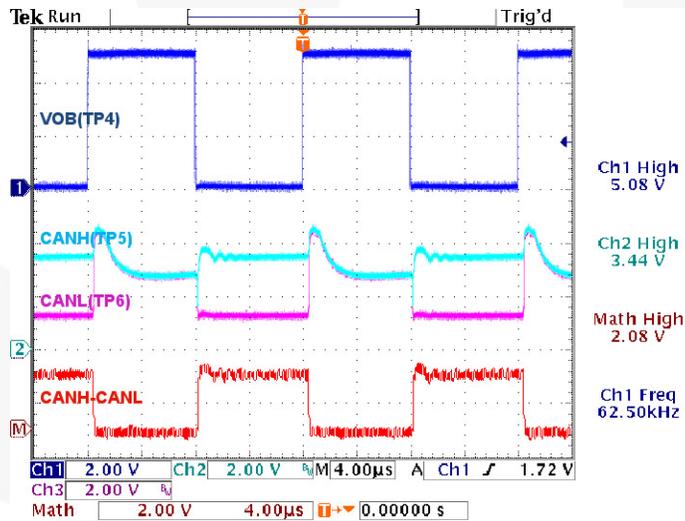


Figure 6. FOD8012 Output Signal, VOB, Drives the RS485 Transceiver; Resulting RS485 Output Signals, V_A and V_B , are Single-Ended Output Signals; $V_{(A-B)}$ = Differential Output Signal

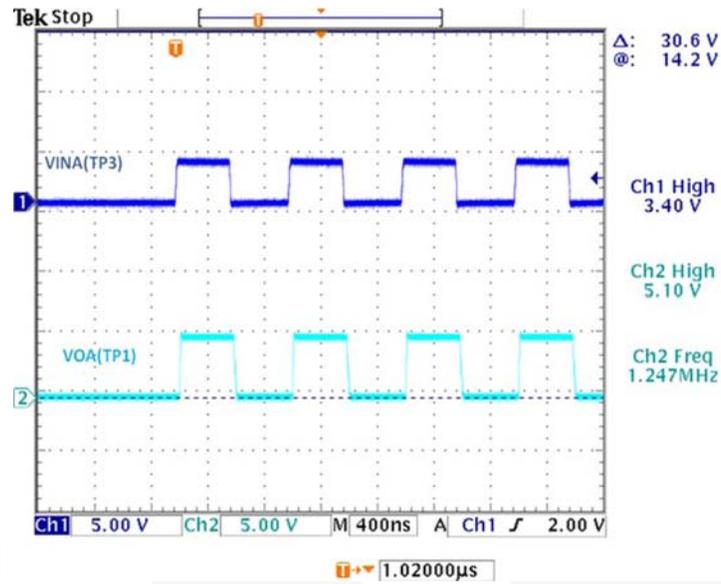


Figure 7. Output Signal from RS485 Transceiver Drives the Input, VINA, of FOD8012; VOA is FOD8012 Output Signal

6. Conclusion

The FEBFOD8012_RS485 evaluation board allows the user to evaluate the performance of the FOD8012 in a bi-directional data-transmission application with the RS485 transceiver. Measurement results clearly demonstrate the high-speed performance of the FOD8012.

7. Revision History

Rev.	Date	Description
1.0.0	August 2012	Initial Release

WARNING AND DISCLAIMER

Replace components on the Evaluation Board only with those parts shown on the parts list (or Bill of Materials) in the Users' Guide. Contact an authorized Fairchild representative with any questions.

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